

File No. - RTF/2018/000022

Federation of Indian Chambers of Commerce and Industry

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Dated: 10-05-2019

ORDER

On behalf of Department of Science & Technology (Govt of India), sanction of Federation of Indian Chambers of Commerce and Industry (FICCI) is hereby accorded for award of ASEAN – India Research & Training Fellowship (AIRTF) under ASEAN – India Science & Technology Development Fund of Govt. of India to Mr. Dai Van Pham, Institute of Materials Science, Vietnam for a period of 6 months starting from 1st June to 30th November, 2019, as per the details given below –

Research Topic	Name of the awardees	Indian Host Institute and duration of the Fellowship
Fiber Biosensor for	Mr. Dai Van Pham, Institute of Materials Science, Vietnam.	Dr. Surinder Singh, Professor (Electronics & Communication Engineering) and Dr. Vinod Kumar Verma, Assistant Professor (Computer Science and Engineering), Sant Longowal Institute of Engineering And Technology (Sliet), Sangrur, Punjab.

The break- up of estimated expenditure is indicated as below-

S. No.	Items of expenditure	Amount
i.	Fellowship amount @Rs. 50,000/- per month for 6 months (all inclusive of accommodation and food etc)	Rs. 3,00,000/-
ii.	International airfare from the nearest international airport from the place of employment i.e., Vietnam to Sangrur, Punjab (India) and back by lowest economy class and subject to actuals.	Rs. 60,000/-
iii.	One-time research contingency grant for research expenses, airport transfers, visa fee (if any), domestic travel etc. (for 6 months) Note: 75% of the one time grant will be transferred to host institute at the start of the fellowship, and remaining 25% on submission of the completion report to DST and FICCI	Rs. 40,000/-
	Total	Rs.4,00,000/-

The total amount of Rs. 3,40,000/- be released to Sant Longowal Institute of Engineering And Technology (Sliet), Sangrur, Punjab, India. The details of the designated bank account of Sant Longowal Institute of Engineering And Technology (Sliet), Sangrur are attached.

The award of this fellowship is subject to the following conditions-

- i. The air ticket for international travel shall be arranged by FICCI by lowest economy class by shortest route on receipt of travel itinerary from fellowship awardees. The fellowship amount sanctioned at (i) and (iii) above shall be released and kept at the disposal of the Indian host University i.e., Sant Longowal Institute of Engineering And Technology (Sliet), Sangrur, Punjab for incurring the expenditure.
- ii. No re-appropriation of funds from one sub-head to another is allowed.
- iii. Submission of Utilization Certificate (UC) and a Statement of Expenditure (SE) along with refund of un-spent balance amount and the technical report of the work done by the fellowship holder within one month of completion of the fellowship period.

(Mr. Nirankar Saxena) Deputy Secretary General, FICCI

To,

- 1. Mr. RK Sharma, Scientist-E (Director Grade), International Multilateral & Regional Cooperation (IMRC), Department of Science & Technology (DST)
- 2. Ms. Ritika Kishore, Deputy Director, FICCI (AIRTF Secretariat)
- 3. Mr. Dai Van Pham, Institute of Materials Science, Vietnam.

Copy to:

- 1. Dr. Surinder Singh, Professor (Electronics & Communication Engineering) and Dr. Vinod Kumar Verma, Assistant Professor (Computer Science and Engineering), Sant Longowal Institute of Engineering And Technology (Sliet), Sangrur, Punjab.
- 2. Head (IMRC), DST, New Delhi-110016
- 3. Chief Financial Officer, FICCI
- 4. Sanction folder/file

(Mr. Nirankar Saxena) Deputy Secretary General, FICCI



Sant Longowal Institute of Engineering & Technology (SLIET) (Deemed to be University under Section 3 of UGC Act, 1956) Longowal, District-Sangrur, Punjab- 148 106

Consent Letter

To

Mr. Dai Van Pham

Department: Key Lab. For Electronic Materials and Devices Institute Of Materials Science, 18 Hoang Quoc Viet Road,

Cau Giay District, Hanoi, Vietnam

Reference: AISTDF Secretariat, International Multilateral Regional Cooperation Division, DST, New Delhi, India. File Number: RTF/2018/000022 Dated: 19-Mar-2019.

Dear Mr. Dai Van Pham,

It gives me immense pleasure to invite you to visit the Department of Electronics and Communication Engineering, Sant Longowal Institute of Engineering and Technology (SLIET), Longowal, Sangrur under ASEAN-India Research and Training fellowship (AI-RTF), DST, New Delhi. The tentative dates for your fellowship are 1st June 2019 to 31th Nov., 2019 under the mentorship of Dr. Surinder Singh, Professor (ECE) and Dr. Vinod Kumar Verma, AP(CSE).

Your stay and other arrangements will made as per the norms of host institute during the tenure of the fellowship.

The bank account details of Indian host institute for receiving the sanctioned funds as follow-

Name of the Account Holder:

Director SLIET

Account Number:

1688335346

Name, Branch and Address of

Central bank of India, SLIET Campus

the Bank

Sant Longowal Institute of Engineering and

Technology, Longowal, Punjab. India

PIN:148106

IFSC Code:

CBIN0283105

Dr. Shailendra Jain
(Director)

Date:

Place: Longowal



Key Action 1 - Mobility for learners and staff Higher Education Student and Staff Mobility Inter-institutional¹ agreement 2017-19²

between institutions from Programme and Partner Countries³

[Minimum requirements]4

The institutions named below agree to cooperate for the exchange of students and/or staff in the context of the Erasmus+ programme. They commit to respect the quality requirements of the Erasmus Charter for Higher Education in all aspects of the organisation and management of the mobility, in particular the recognition of the credits (or equivalent) awarded to students by the partner institution. The institutions also commit to sound and transparent management of funds allocated to them through Erasmus+.

A. Information about higher education institutions

	(email, phone)	(eg. of the course catalogue)
G ATHINE34	Prof. Dr. George Panagiaris, Institutional Coordinator gpanag@teiath.gr euroffic@teiath.gr intermobility@teiath.gr	http://www.telath.gr/diethnwn/?la ng—en
	Prof. Dr. Klimis Ntalianis, Department of Marketing kdal75@gmail.com	http://www.teiath.gr/intra_depart mental/ http://www.ma.teiath.gr/en
LONGOWAL	Prof. Dr. Vinod Kumar Verma, Assistant Professor, Department of Computer Science and Engineering vinod5881@gmail.com	http://www.sliet.ac.in
		Institutional Coordinator gpanag@teiath.gr euroffic@teiath.gr intermobility@teiath.gr Prof. Dr. Klimis Ntalianis, Department of Marketing kdal75@gmail.com Prof. Dr. Vinod Kumar Verma, Assistant Professor, Department of Computer Science and Engineering

¹ Inter-institutional agreements can be signed by two or more higher education Institutions (HEIs), at least one of them must be located in a Programme Country of Erasmus F.

 $^{^\}circ$ Higher Education Institutions have to agree on the period of validity of this agreement. The mobilities must be completed till May 2019.

³ Erasmus + Programme Countries are the 28 EU countries, the FFTA countries and other European countries as defined in the Call for proposals. Eligible Partner Countries are listed in the Programme Guide.

⁴ Clauses may be added to this template agreement to better reflect the nature of the institutional partnership.
⁵ Higher Education Institutions (NE)) from Engineering Descriptions

SHigher Education Institutions (HEJ) from Erasmus + Programme Countries should indicate their Erasmus code while Partner Country HEIs should mention the city where they are located.

⁶ Contact details to reach the senior officer in charge of this agreement.

Institution [Erasmus code of city]		Website for information
G ATHINE34	intermobility@telath.gr + 30 210 5385 165	http://www.teiath.gr/diethnwn/articles.php?id=21875⟨=en
LONGOWAL .	Vinod5881@gmail.com +91.9417927536	http://www.sliet.ac.in
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Following are the modalities for the International mobility program from SLIET Longowal side.

- There is No financial obligation at SLIET Longowal for this program and all the mobilities will be covered by TEI of Athens as already mentioned in the attached Email dated 29/09/2017.
- 2. The Travelling Allowance and Daily Allowance of Dr. Vinod Kumar Verma for this program will be covered by TEI of Athens.
- 3. The Key Action-1 Performa is for the Faculty mobility program only (Dr. Vinod Kumar Verma, AP, CSE, SLIET, Longowal).
- 4. The faculty from the TEI of Athens will visit the SLIET at the funding from TEI of Athens. There is no financial obligation at SLIET end for the same.
- 5. SLIET Longowal will provide only Boarding and Lodging facility to the faculty from TEI of Athens for this program.

G. SIGNATURES OF THE INSTITUTIONS (legal representatives)

Institution [Erasmus code or name and city]	Name, function	Date Signatúre ⁹
G ATHINE34	Prof. Dr. Maria Venetikou Rector	18/10/18/1
LONGOWAL	Prof. Dr. V.K. Jain Director	10-10 मिट्राक

Sant Longowal Institute of Engg. & Tech सेन लीगोवाल अभियांत्रिको एवं प्रौद्यागिको संस्थान

Longowal - 148106, Punjab (India) लीगांबाल मोसूबर, पंजाब १४६१०६

Dr. Vinod Kumar Verma

Assistant Professor, Department of Computer Science and Engineering Sant Longowal Institute of Engineering and Technology

Longowal

⁹ Scanned copies of signatures or digital signatures may be accepted depending on the national legislation



Erasmus+ Programme

Key Action 1 - Mobility for learners and staff -Higher Education Student and Staff Mobility

Inter-institutional¹ agreement 2019-27²

between programme countries

[Minimum requirements]3

The institutions named below agree to cooperate for the exchange of students and/or staff in the context of the Erasmus+ programme. They commit to respect the quality requirements of the Erasmus Charter for Higher Education in all aspects related to the organisation and management of the mobility, in particular the recognition of the credits awarded to students by the partner institution.

A. Information about higher education institutions

Name of the institution (and department, where relevant)	Erasmus code	Contact details ⁴ (email, phone)	Website* (eg. of the course catalogue)
UNIVERSITY OF WEST ATTICA (UNIWA) Campus 1 Ag. Spiridonos 28 AIGALEO 12243, Greece	G EGALEO 02	Associate Prof. Konstantinos-Stefanos NIKAS, ERASMUS+ / ICM Institutional Coordinator, Tel: +30 210 538 1234 e-mail: ksnikas@uniwa.gr	http://erasmusglo bal.uniwa.gr/
Campus 2 P. Ralli & Thivon 250 AIGALEO 12244, Greece	2 6 8 -3	Fani A. PAPOUTSI Irene - Athena VATOU E+ ICM Administration Officers, Tel: +30 210 538 1185 Fax: +30 210 561 3703	

¹ Inter-institutional agreements can be signed by two or more higher education institutions

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² Higher Education Institutions have to agree on the period of validity of this agreement

³Clauses may be added to this template agreement to better reflect the nature of the institutional partnership.

 $^{^4}$ Contact details to reach the senior officer in charge of this agreement and of its possible updates.

Institution [Erasmus code]	Contact details (email, phone)	Website for information
G EGALEO02	Fani A. PAPOUTSI, Irene - Athena VATOU Tel: +30 210 538 1185 e-mail: erasmus.global@uniwa.gr	http://erasmusglobal.uniwa.gr/
908338653	Dr. Vinod Kumar Verma Tel: +91 9417927536 e-mail: Vinod5881@gmail.com	http://www.sliet.ac.in/

G. SIGNATURES OF THE INSTITUTIONS (legal representatives)

Institution [Erasmus code]	Name, function	Date	Signature ⁸
908338653	Professor Parmjit S. Panesar Dean (Research & Consultancy) Sant longowal Institute of Engineering and Technology Longowal, Punjab, INDIA deanrandc@sliet.ac.in	13.2.2020	Maur
	अधिष्ठाता (शोध एं परामर्श) Dean (Research & Consultancy)		Continuous institute or English facts. Longowat 1492 House
G EGALEO02	Professor Savvas VASSILIADIS UNIWA Member of the Committee, ERASMUS+ Legal Representative (Institutional Coordinator) svas@uniwa.gr	20.2.2020	THAT OF WEST A

Dr. Vinod Kumar Verma
Assistant Professor
Department of Computer Science and Engineering

Sant Longowal Institute of Engineering and Technology (SLIET) Longowal – 148106, Punjab, INDIA

⁸Scanned signatures are accepted